

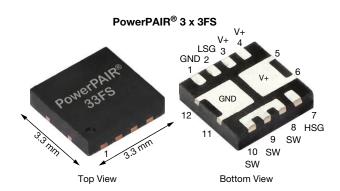
COMPLIANT

HALOGEN

FREE



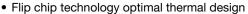
# Dual N-Channel 30 V (D-S) MOSFET

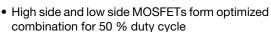


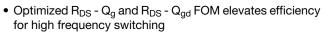
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	30				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.00243				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.00351				
Q <sub>g</sub> typ. (nC)	9.5				
I <sub>D</sub> (A)	125 <sup>a</sup>				
Configuration	Dual				

### **FEATURES**

- TrenchFET® Gen V power MOSFET
- Symmetric dual N-channel



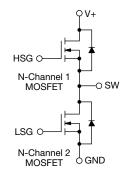




- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

### **APPLICATIONS**

- Synchronous buck
- Computer / server peripherals
- Half bridge
- POL
- Telecom DC/DC



ORDERING INFORMATION	
Package	PowerPAIR 3 x 3FS
Lead (Pb)-free and halogen-free	SIZF5300DT-T1-GE3

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V <sub>DS</sub>	30	V	
Gate-source voltage		V <sub>GS</sub>	+16 / -12	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		125		
	T <sub>C</sub> = 70 °C		100		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	35 b, c		
	T <sub>A</sub> = 70 °C		28 b, c		
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	150	A	
Continuous source current (MOSFET diode conduction)	T <sub>C</sub> = 25 °C		47.3		
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	3.7 b, c		
Single pulse avalanche current	. 0.1!!	I <sub>AS</sub>	20		
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	20	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		56.8		
	T <sub>C</sub> = 70 °C		36.4	w	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	4.5 b, c	VV	
	T <sub>A</sub> = 70 °C		2.9 b, c		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150		
Soldering recommendations (peak temperature)		Ŭ	260	°C	

### Notes

- a.  $T_C = 25 \,^{\circ}C$
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s



# Vishay Siliconix

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient a, b	t ≤ 10 s	R <sub>thJA</sub>	22	28	°C/W	
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	1.7	2.2		

#### Notes

- a. Surface mounted on 1" x 1" FR4 board
- b. Maximum under steady state conditions is 64 °C/W

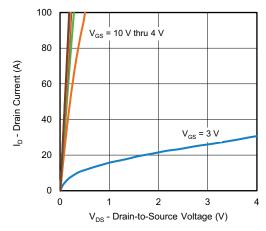
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	•				. "		
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$ 30		-	-	V	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	-	2	V V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = +16 \text{ V} / -12 \text{ V}$	-	-	± 100	nA	
Zoro goto voltago droin current	I <sub>DSS</sub>	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V	-	-	1	μА	
Zero gate voltage drain current		V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	5		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30	-	-	Α	
Drain accurac on state reciptores 8	В	$V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	0.00202	0.00243	Ω	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 7 A	-	0.00293	0.00351		
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 10 A	-	61	=	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	1480	-	pF	
Output capacitance	C <sub>oss</sub>		-	500	-		
Reverse transfer capacitance	C <sub>rss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	35	-		
C <sub>rss</sub> /C <sub>iss</sub> ratio			-	0.023	0.055		
Tatal acts chares	0	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A	-	21	32		
Total gate charge	Qg		-	9.5	15	nC	
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$	-	5.5	-		
Gate-drain charge	Q <sub>gd</sub>		-	1.7	-		
Gate resistance	$R_g$	f = 1 MHz	0.18	0.9	1.8	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	12	24		
Rise time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_1 = 1 \Omega, I_D \cong 15 \text{ A},$	-	8	16		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	25	50		
Fall time	t <sub>f</sub>		-	6	12		
Turn-on delay time	t <sub>d(on)</sub>		-	22	44	ns	
Rise time	t <sub>r</sub>	$\begin{split} V_{DD} = 15 \ V, \ R_L = 1 \ \Omega, \ I_D \cong 15 \ A, \\ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega \end{split}$	-	48	96		
Turn-off delay time	t <sub>d(off)</sub>		-	22	44		
Fall time	t <sub>f</sub>		-	12	24		
<b>Drain-source Body Diode Characteris</b>	tics			•			
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25°C	-	-	47.3		
Pulse diode forward current	I <sub>SM</sub>		-	-	150	Α	
Body diode voltage	$V_{SD}$	I <sub>S</sub> = 15 A, V <sub>GS</sub> = 0 V	-	0.85	1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	17	34	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = 15 A, di/dt = 100 A/μs,	-	6	12	nC	
Reverse recovery fall time	ta	T <sub>J</sub> = 25 °C	-	9	-		
Reverse recovery rise time	t <sub>b</sub>		-	8	-	ns	

## Notes

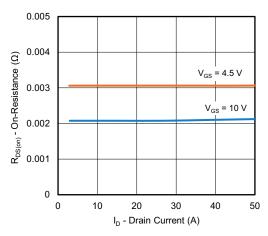
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

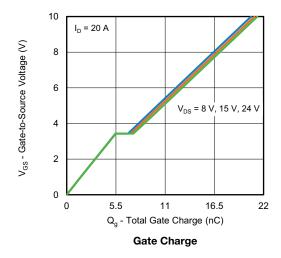


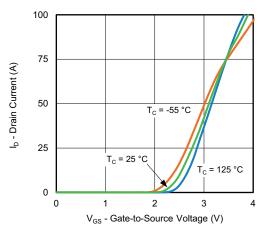


## **Output Characteristics**

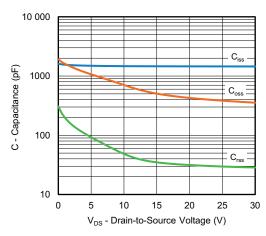


On-Resistance vs. Drain Current and Gate

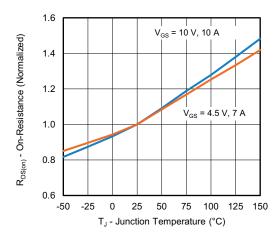




**Transfer Characteristics** 

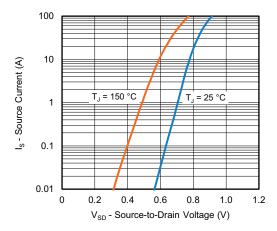


Capacitance

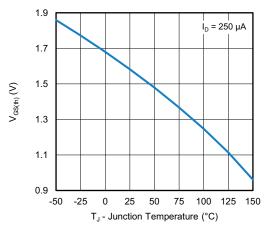


**On-Resistance vs. Junction Temperature** 

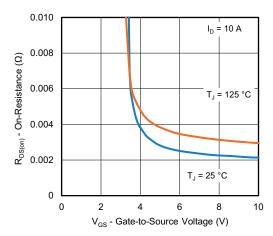




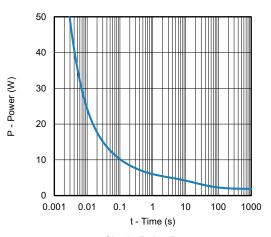
### Source-Drain Diode Forward Voltage



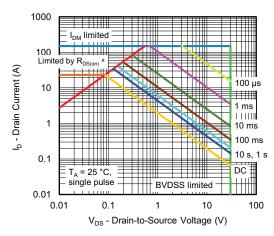
**Threshold Voltage** 



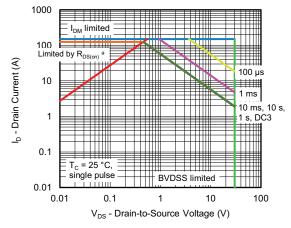
On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power



Safe Operating Area, Junction to Ambient

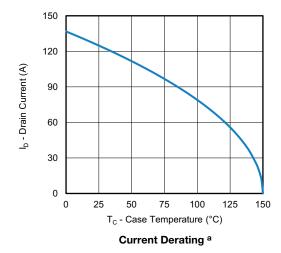


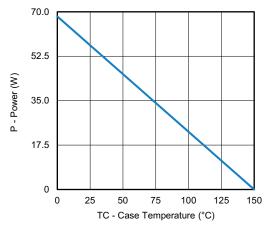
Safe Operating Area, Junction to Case

## Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified





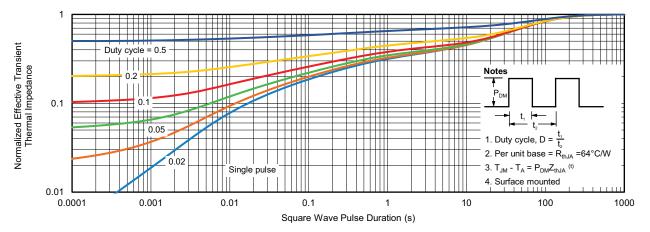


Power, Junction-to-Case

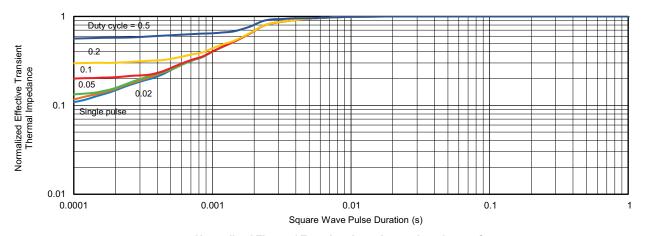
#### Notes

- a. The power dissipation  $P_D$  is based on  $T_J$  max. = 150 °C, using junction-to-ambient thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit
- b. V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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